504607650 10/24/2017

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
STHANUNATHAN RAMAKRISHNAN	10/19/2017
SASHIDHARAN VENKATRAMAN	10/19/2017
CHANDRASEKHAR SRIRAM	10/19/2017
JAWAHARLAL TANGUDU	10/23/2017

RECEIVING PARTY DATA

Name:	TEXAS INSTRUMENTS INCORPORATED
Street Address:	12500 TI BOULEVARD
Internal Address:	M/S 3999
City:	DALLAS
State/Country:	TEXAS
Postal Code:	75243

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15791538

CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 214-479-1230 Email: uspto@ti.com

Correspondent Name: TEXAS INSTRUMENTS INCORPORATED

Address Line 1: P O BOX 655474, M/S 3999 Address Line 4: DALLAS, TEXAS 75265

ATTORNEY DOCKET NUMBER:	TI-78050
NAME OF SUBMITTER:	MICHAEL J. GUTHRIE
SIGNATURE:	/Michael J. Guthrie/
DATE SIGNED:	10/24/2017

Total Attachments: 2

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PATENT REEL: 043931 FRAME: 0109

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PATENT REEL: 043931 FRAME: 0110

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to India Provisional Application No(s), 201641042879, filed December 6, 2016;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. I hereby sell and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof, and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby self and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful paths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date herein below.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE	BAND SPECIFIC INTERLEAVING MISMATCH COMPENSATION IN RF ADCS		
NONPROVISIONAL APPLICATION NO.	15/791,538	FILING DATE	October 24, 2017
SIGNATURE OF INVENTOR	2 Against Sans		
PRINTED NAME OF INVENTOR	Sthanunathan RAMAKRISH	INAN	
DATE	19h oct 2017		
RESIDENCE (CITY AND STATE)	Bengaluru, India		:

734756-41/3360-13160

SIGNATURE OF INVENTOR	Gardindhama
PRINTED NAME OF INVENTOR	Sashidharan VENKATRAMAN
DATE	19th Oct 2017
RESIDENCE (CITY AND STATE)	Hyderabad, India

SIGNATURE OF INVENTOR	S. Overdrader
PRINTED NAME OF INVENTOR	Chandrasekhar SRIRAM
DATE	19th OCT 2017
RESIDENCE (CITY AND STATE)	Chennai, India

SIGNATURE OF INVENTOR	Titawahaslal
PRINTED NAME OF INVENTOR	Jawaharlal TANGUDU
DATE	23 ⁸⁸ Oct 2017
RESIDENCE (CITY AND STATE)	Hyderabad, India

After recording, return Assignment to:

Texas Instruments Incorporated PO Box 655474, M/S 3999 Dallas, Texas 75265

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